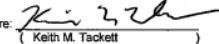


I hereby certify that this paper (along with any paper referred to as being attached or enclosed) is being transmitted via the Office electronic filing system in accordance with § 1.6(a)(4).

Dated: 6/11/09

Signature:



Keith M. Tackett

Docket No.: APPM/008244US/DSM/BCVD/JW
1016.014014
(PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Yuxiang May Wang, et al.

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Group Art Unit: 2893

Serial No.: 10/799,146

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Confirmation No.: 7933

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Examiner: M. D. Harrison

Filed: March 12, 2004

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For: METHOD OF
DEPOSITING AN AMORPHOUS
CARBON FILM FOR ETCH
HARDMASK APPLICATION

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AMENDMENT IN RESPONSE TO NON-FINAL OFFICE ACTION

MS Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Madam:

INTRODUCTORY COMMENTS

In response to the Office Action dated March 6, 2009, having a shortened statutory period for response set to expire on June 6, 2009, please enter this response and reconsider the claims pending in the application for reasons discussed below. Although Applicant believes that no additional fees are due in connection with this response, the Commissioner is hereby authorized to charge counsel's Deposit Account No. 20-0784/APPM/008244US/DSM/BCVD/JW/KMT, for any fees, including extension of time fees or excess claim fees, required to make this response timely and acceptable to the Office.

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper. **Remarks** begin on page 7 of this paper.